	connecto	ors
	SPECIFICATIO	Ν
宏致	如電子股份有	限公司
	桃園縣中壢市東園路13	號
	No.13, Dongyuan Rd., Jhongli	City,
	Taoyuan County 320, Taiwan (R	.O.C.)
	TEL: +886-3-463-2808 FAX: +886-3-463-1800	
SPEC. NO.: <b>PS-509</b>	12-XXXX-XXX RI	EVISION: B
<b>PRODUCT NAME:</b>	SAS CONN. RCPT. S/T. SMT	ТҮРЕ
PRODUCT NO:	50912 SERIES ; 51898 SERIE	ES ;
PREPARED:	CHECKED:	APPROVED:
Tang,En Hui	Lu,Jing Quan	hsieh,fu yu
DATE: 2018/07/11	DATE: 2018/07/11	DATE: 2018/07/11

2010/10/31 TR-FM-73015L

ICES			Aces P/N: 50912-xxxxx-xxx series						
TITLE:	SAS CONN. RCI	PT. S/T. SM	ГТҮРЕ						
RELEASE D	ATE: 2018/07/11	REVISION: B		ECN No:1807154	PAGE: <b>2</b> OF <b>9</b>				
1	<b>REVISION HIST</b>	ORY			3				
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5	PERFORMANCE				5				
6	INFRARED REF	LOW COND	ITION		7				
7	PRODUCT QUAI	_IFICATION	AND TEST	SEQUENCE	9				

# Aces P/N: 50912-xxxx-xxx series

### TITLE: SAS CONN. RCPT. S/T. SMT TYPE

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# **1** Revision History

Rev.	ECN #	Revision Description	Prepared	Date
1	ECN-1103018	NEW SPEC	HUANTY	2011/03/12
0	ECN-1107001	MODIFY TERMINAL & FITTING NAIL RETENTION FORCE	HUANTY	2011/07/01
01	ECN-1108100	ADD MATED CONNECTOR DIFFERENTIAL IMPEDANCE TEST	HUANTY	2011/08/03
Α	ECN-1109263	FOR ECR-1108004 RELEASE	HUANTY	2011/9/24
В	ECN-1807154	ADD 51898 SERIES	Tang,En Hui	2018/07/11

	CONNECTORS	Aces P/N: 50912-xxxxx-xxx series	
Т	ITLE: SAS CONN. RCPT. S/T. SM	TYPE	
REL	EASE DATE: 2018/07/11 REVISION: B	ECN No:1807154 PAGE	<b>4</b> OF <b>9</b>
2	SCOPE This specification covers performa Refer to ACES P/N: 50912 series	nce, tests and quality requirements for SAS c	onnector.
3	APPLICABLE DOCUMENTS		
	EIA-364: ELECTRONICS INDUSTR	ES ASSOCIATION	
4	REQUIREMENTS		
	4.1 Design and Construction		
	product drawing.	construction and physical dimensions specified on appl .H.S. and the standard depends on TQ-WI-140101.	icable
	4.2 Materials and Finish		
	Finish: (a) Contact Ar (b) Under plate (c) Solder area 4.2.2 Housing: Thermoplastic o 4.2.3 Fitting nail: High performa Finish: (a) Contact Ar	ce copper alloy (Phosphor Bronze) a: Refer to the drawing. : Refer to the drawing. : Refer to the drawing. - Thermoplastic High Temp., UL94V-0 nce copper alloy a: Refer to the drawing. : Refer to the drawing.	
	4.3 Ratings		
	<ul> <li>4.3.1 Voltage: 30 Volts DC (per</li> <li>4.3.2 Current: 1.5 Amperes (per</li> <li>4.3.3 Operating Temperature : 0</li> <li>Non-Operating Temperature</li> </ul>	pin) ℃ to +55℃	

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TITLE: SAS CONN. RCPT. S/T. SMT TYPE

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# 5 Performance

## 5.1. Test Requirements and Procedures Summary

ltem	Requirement	Standard				
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.				
	ELECTRICAL					
ltem	Requirement	Standard				
Low Level Contact Resistance	$30 \text{ m }\Omega$ Max.(initial)per contact 15 m $\Omega$ Max.(after test) Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)				
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)				
Mated connector Differential Impedance 100 Ω ±15%		<ul> <li>1. Set the Time Domain Reflectometer (TDR) pulse in differential mode with a positive going (V+) and a negative going pulse (V-). Define a reflected differential trace: Vdiff=V+ - V-</li> <li>2. With the TDR connected to the rise time reference trace, verify an input rise time to 70ps (20%-80%) as practical.</li> <li>3. Measure and record the maximum and minimum values of the near end connector differential impedance.</li> </ul>				
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 0.5 m A max.	500V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)				
Temperature rise 30℃ Max. Change allowed		Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1				
	MECHANICAL					
ltem	Requirement	Standard				
Durability	500 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of $25.4 \pm 3$ mm/min, (200 cycles per hour max.) (EIA-364-09)				

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Item	Requirement	Standard			
Mating / Un-mating Forces	Mating Force: 25N (2.55kgf) Max. Un-mating Force: 5N (0.5kgf) Min.	Operation Speed : 25.4 ± 3 mm/minute Measure the force required to mate/Un-mate connector. (EIA-364-13)			
Terminal / Housing Retention Force	3.43N(0.35kgf) MIN.	Apply axial pull out force at the speed rate of $25.4 \pm 3$ mm/minute. On the terminal assembled in the housing.			
Fitting nail / Housing Retention Force	3.1N(0.3kgf) MIN.	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.			
Vibration	1 µ s Max.	The electrical load condition shall be 100 m A maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)			
Shock (Mechanical)	1 µs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)			
	ENVIRONMENTA	L			
ltem	Requirement	Standard			
Resistance to <b>Reflow</b> Soldering Heat	See Product Qualification and Test Sequence Group 9 (Lead Free)	Pre Heat : 150℃~180℃, 60~120sec. Heat : 230℃ Min., 40sec Min. Peak Temp. : 260℃Max, 10sec Max.			

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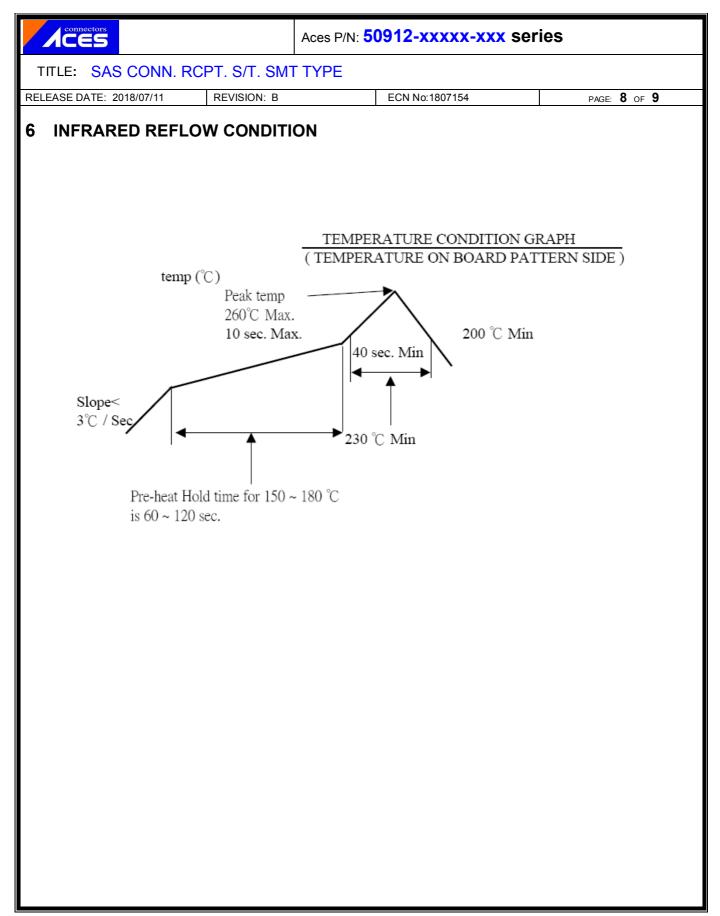
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ltem	Requirement	Standard Mate module and subject to follow condition for 10 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)				
Thermal Shock	See Product Qualification and Test Sequence Group <mark>4</mark>					
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)				
Temperature life	See Product Qualification and Test Sequence Group <mark>5</mark>	Subject mated connectors to				
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group <mark>6</mark>	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)				
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)				
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.				

Note. Flowing Mixed Gas shell be conduct by customer request.



CES	A	ces P/N	1: <b>50</b> 9	912-x	(XXX)	x-xx)	< ser	ries			
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7 PRODUCT QUALIFICATION	ANC	) TES	T SE	QUE	NCE						
	Test Group										
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
	Test Sequence										
Examination of Product				1、7	1、6	1、4			1	1	1
Low Level Contact Resistance		1、5	1、4	2、10	2 • 9	2 \ 5			3		
Insulation Resistance				3、9	3、8						
Dielectric Withstanding Voltage				4 • 8	4、7						
Temperature rise	1										
Mating / Unmating Forces		2、4									
Durability		3									
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
Mated connector Differential Impedance											2
Terminal / Housing Retention Force							1				
Fitting Nail /Housing Retention Force								2			
Resistance to Soldering Heat									2		
Hand Soldering Temperature Resistance										2	
Sample Size	2	4	4	4	4	4	2	4	4	4	4